

N-Channel Super Junction Power MOSFET $\, \mathrm{I\!V}$

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

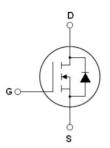
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- New technology for high voltage device
- ●Low on-resistance and low conduction losses
- ●Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

V _{DS min@Tjmax}	550	V
R _{DS(ON)TYP} .	280	mΩ
I_D	10	Α
Qg	12.5	nC



Schematic diagram

♦ Intrinsic fast-recovery body diode

Package Marking And Ordering Information

Device	Device Package	Marking
NCE50NF330F	TO-220F-3L	NCE50NF330F



TO-220F

Table 1. Absolute Maximum Ratings (Tc=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (Vgs=0V)	VDS	500	V
Gate-Source Voltage (V _{DS} =0V) ,AC (f>1 Hz)	V _G s	±30	V
Gate-Source Voltage (V _{DS} =0V) ,DC	V _G s	±20	V
Continuous Drain Current at Tc=25°C	I _{D (DC)}	10	Α
Continuous Drain Current at Tc=100°C	I _{D (DC)}	7	Α
Pulsed drain current (Note 1)	I _{DM} (pluse)	30	Α
Maximum Power Dissipation(Tc=25℃)	P _D	31.6	W
Derate above 25°C		0.21	W/°C
Single pulse avalanche current (Note 2)	I _{AS}	2.5	Α
Reverse diode dv/dt, $V_{DS} \leq 480 \text{ V,I}_{SD} < I_{D}$	dv/dt	15	V/ns
Drain Source voltage slope,V _{DS} ≤480 V	dv/dt	50	V/ns
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55+175	°C



Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance,Junction-to-Case(Maximum)	R _{thJC}	4.74	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	62	°C /W

 Table 3. Electrical Characteristics (TA=25℃unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250uA	500			V
Zero Gate Voltage Drain Current(Tc=25°ℂ)	I _{DSS}	V _{DS} =500V,V _{GS} =0V			10	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =500V,V _{GS} =0V			300	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±200	nA
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250uA$	3		5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =5A		280	330	mΩ
Dynamic Characteristics						
Gate Resistance	Rg	F=1MHZ, D-S short		37		Ω
Input Capacitance	C _{lss}	., 50,/./. 0./		545		pF
Output Capacitance	Coss	$V_{DS}=50V, V_{GS}=0V,$		36		pF
Reverse Transfer Capacitance	C _{rss}	F=1MHz		4		pF
Total Gate Charge	Qg			12.5	15.5	nC
Gate-Source Charge	Q _{gs}	V_{DS} =400 V , I_{D} =5 A ,		5		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V		3.5		nC
Gate plateau voltage	Vgp			6.5		V
Switching times						
Turn-on Delay Time	t _{d(on)}			9		nS
Turn-on Rise Time	tr	V_{DD} =380 V , I_{D} =5 A ,		12		nS
Turn-Off Delay Time	t _{d(off)}	R_G =4 Ω , V_{GS} =10 V		43		nS
Turn-Off Fall Time	t _f			10		nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T 05°0			10	Α
Pulsed-Source-drain current(Body Diode)	I _{SDM}	T _C =25°C			30	Α
Forward on voltage	V _{SD}	Tj=25°C,I _{SD} =10A,V _{GS} =0V		1.0	1.2	V
Reverse Recovery Time	t _{rr}			135		nS
Reverse Recovery Charge	Q _{rr}	Tj=25°C,IF5A,		0.37		uC
Peak reverse recovery current	I _{rrm}	di/dt=100A/µs		5.5		Α

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25 $^{\circ}\text{C}$,VDD=50V,VG=10V, RG=25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Output characteristics

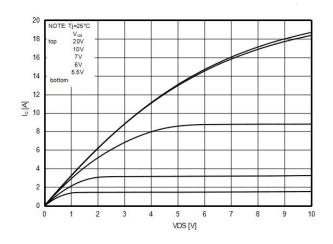


Figure 2. Transfer characteristics

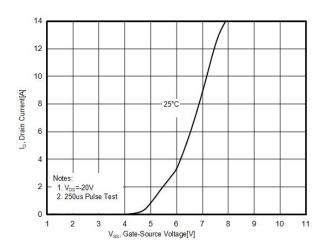


Figure 3. R_{DS(ON)} vs Junction Temperature

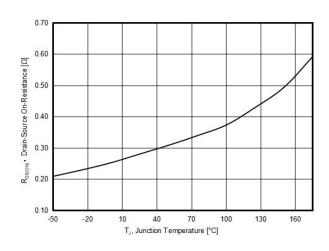


Figure 4. BV_{DSS} vs Junction Temperature

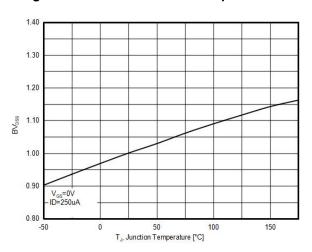


Figure 5. Maximum ID vs Junction Temperature

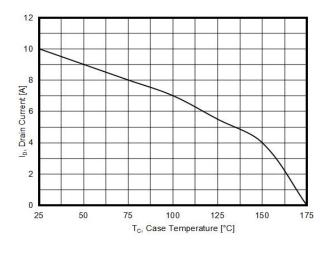
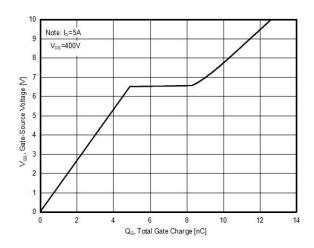


Figure 6. Gate charge waveforms



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Figure 7. Static drain-source on resistance

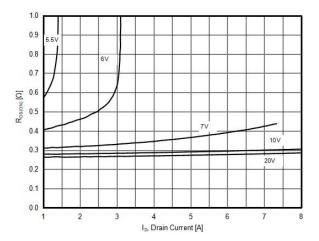


Figure9. Capacitance

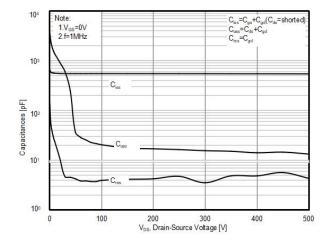


Figure8. Source-Drain Diode Forward Voltage

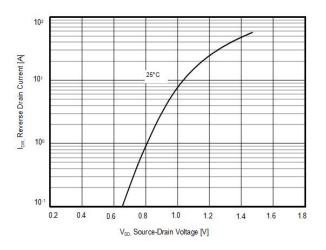
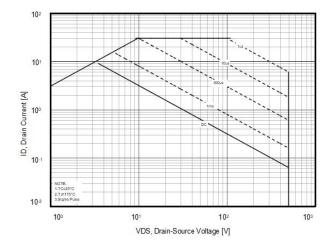


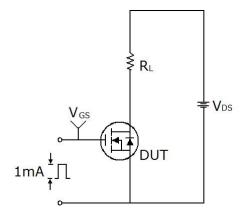
Figure 10. Safe operating area

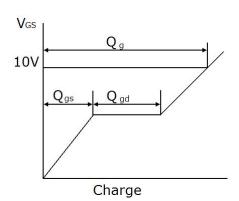




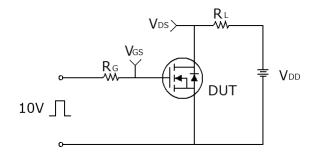
Test circuit

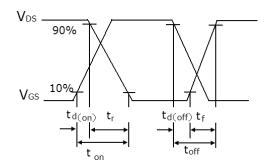
1) Gate charge test circuit & Waveform



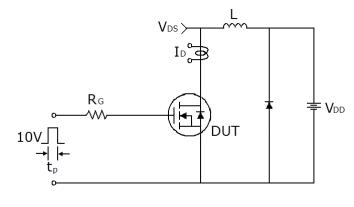


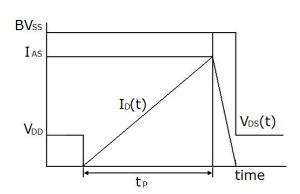
2) Switch Time Test Circuit:





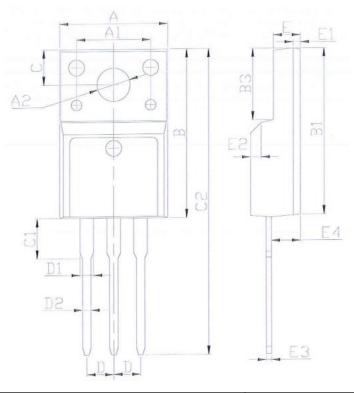
3) Unclamped Inductive Switching Test Circuit & Waveforms







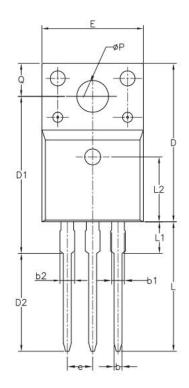
TO-220F-3L-L Package Information

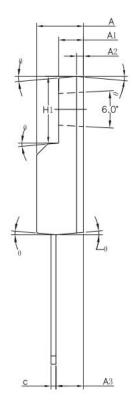


Symbol	Dimensions	In Millimeters	Dimensions	s In Inches
	Min.	Max.	Min.	Max.
A	9.86	10.46	0.387	0.411
A1	6.80	7.20	0.267	0.283
A2	2.92	3.32	0.115	0.130
A3	9.40	10.00	0.369	0.393
В	15.40	16.40	0.605	0.644
B1	15.10	16.10	0.593	0.633
B2	4.40	5.00	0.173	0.196
B3	6.40	7.00	0.251	0.275
С	3.05	3.55	0.120	0.139
C1	2.95	3.55	0.116	0.139
C2	28.20	29.20	1.108	1.147
D	2.54	4 BSC	0.100 BSC	
D1		1.47		0.058
D2	0.60	1.00	0.024	0.039
E	2.30	2.80	0.090	0.110
E1	0.45	0.95	0.018	0.037
E2	4	45.0°)0°
E3	0.30	0.70	0.012	0.028
E4	2.45	3.05	0.096	0.120



TO-220F-3L-P Package Information





Symbol	Dimensions	In Millimeters	Dimensions In Inches	
	Min.	Max.	Min.	Max.
А	4.50	4.83	0.177	0.190
A1	2.34	2.74	0.092	0.108
A2	0.70	REF	0.028	REF
A3	2.56	2.93	0.101	0.115
b	0.70	0.90	0.028	0.035
b1	1.18	1.38	0.046	0.054
b2		1.47		0.058
С	0.45	0.60	0.018	0.024
D	15.67	16.07	0.616	0.631
D1	15.55	15.95	0.611	0.627
D2	9.60	10.00	0.377	0.393
E	9.96	10.36	0.391	0.407
е	2.54	4 BSC	0.100	BSC
H1	6.48	6.88	0.255	0.270
L	12.68	13.28	0.498	0.522
L1		3.50		0.138
L2	6.50 REF		0.255	REF
Ø P	3.08	3.28	0.121	0.129
Q	3.20	3.40	0.126	0.134



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